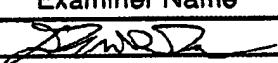
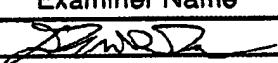
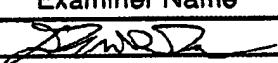


ELECTRONIC INFORMATION DISCLOSURE STATEMENT

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10/709,869

Title of Invention	IMPROVED PROCESS FOR FORMING A BURIED PLATE																																																																						
<p>Application Number: 10/709,869 Confirmation Number: First Named Applicant: Cheng Kangguo Attorney Docket Number: FIS920040065US1 Art Unit: Examiner: Search string: (5871811 or 6001684 or 6057216 or 6218319 or 6316310 or 6365485 or 6544856 .pn</p>																																																																							
<h3>US Patent Documents</h3> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td>1</td><td>1</td><td>5871811</td><td>1999-02-16</td><td>Wang, et al.</td><td>—</td><td>—</td><td>—</td></tr><tr><td>1</td><td>2</td><td>6001684</td><td>1999-12-14</td><td>Shen</td><td>—</td><td>—</td><td>—</td></tr><tr><td>1</td><td>3</td><td>6057216</td><td>2000-05-02</td><td>Economikos, et al.</td><td>—</td><td>—</td><td>—</td></tr><tr><td>1</td><td>4</td><td>6218319</td><td>2001-04-17</td><td>Dutron, et al.</td><td>—</td><td>—</td><td>—</td></tr><tr><td>1</td><td>5</td><td>6316310</td><td>2001-11-13</td><td>Wensley, et al.</td><td>—</td><td>—</td><td>—</td></tr><tr><td>1</td><td>6</td><td>6365485</td><td>2002-04-02</td><td>Shiao, et al.</td><td>—</td><td>—</td><td>—</td></tr><tr><td>1</td><td>7</td><td>6544856</td><td>2003-04-08</td><td>Morhard, et al.</td><td>—</td><td>—</td><td>—</td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	1	1	5871811	1999-02-16	Wang, et al.	—	—	—	1	2	6001684	1999-12-14	Shen	—	—	—	1	3	6057216	2000-05-02	Economikos, et al.	—	—	—	1	4	6218319	2001-04-17	Dutron, et al.	—	—	—	1	5	6316310	2001-11-13	Wensley, et al.	—	—	—	1	6	6365485	2002-04-02	Shiao, et al.	—	—	—	1	7	6544856	2003-04-08	Morhard, et al.	—	—	—
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